


Small Outline Optoisolators Transistor Output

These devices consist of a gallium arsenide infrared emitting diode optically coupled to a monolithic silicon phototransistor detector, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications, and eliminate the need for through-the-board mounting.

- Convenient Plastic SOIC-8 Surface Mountable Package Style
- Closely Matched Current Transfer Ratios
- Minimum $V_{(BR)CEO}$ of 70 Volts Guaranteed
- Standard SOIC-8 Footprint, with 0.050" Lead Spacing
- Compatible with Dual Wave, Vapor Phase and IR Reflow Soldering
- High Input-Output Isolation of 3000 Vac (rms) Guaranteed
- UL Recognized  File #E90700, Volume 2

Ordering Information:

- To obtain MOC205, 206, 207, 208 in Tape and Reel, add R2 suffix to device numbers:
R2 = 2500 units on 13" reel
- To obtain MOC205, 206, 207, 208 in quantities of 50 (shipped in sleeves) — No Suffix

Marking Information:

- MOC205 = 205
- MOC206 = 206
- MOC207 = 207
- MOC208 = 208

Applications:

- Feedback Control Circuits
- Interfacing and coupling systems of different potentials and impedances
- General Purpose Switching Circuits
- Monitor and Detection Circuits

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

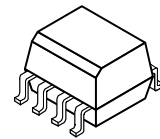
Rating	Symbol	Value	Unit
INPUT LED			
Forward Current — Continuous	I_F	60	mA
Forward Current — Peak (PW = 100 μs , 120 pps)	$I_{F(pk)}$	1.0	A
Reverse Voltage	V_R	6.0	V
LED Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	90 0.8	mW mW/ $^\circ\text{C}$

OUTPUT TRANSISTOR

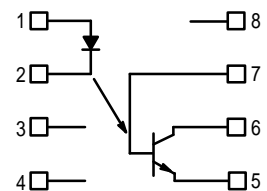
Collector-Emitter Voltage	V_{CEO}	70	V
Collector-Base Voltage	V_{CBO}	70	V
Emitter-Collector Voltage	V_{ECO}	7.0	V
Collector Current — Continuous	I_C	150	mA
Detector Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	150 1.76	mW mW/ $^\circ\text{C}$

MOC205
MOC206
MOC207
MOC208

**SMALL OUTLINE
OPTOISOLATORS
TRANSISTOR OUTPUT**



SCHEMATIC



1. LED ANODE
2. LED CATHODE
3. NO CONNECTION
4. NO CONNECTION
5. EMITTER
6. COLLECTOR
7. BASE
8. NO CONNECTION

MAXIMUM RATINGS — continued ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
TOTAL DEVICE			
Input–Output Isolation Voltage ^(1,2) (60 Hz, 1.0 sec. duration)	V_{ISO}	3000	Vac(rms)
Total Device Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	250 2.94	mW mW/°C
Ambient Operating Temperature Range ⁽³⁾	T_A	–45 to +100	°C
Storage Temperature Range ⁽³⁾	T_{stg}	–45 to +125	°C
Lead Soldering Temperature (1/16" from case, 10 sec. duration)	—	260	°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)⁽⁴⁾

Characteristic	Symbol	Min	Typ ⁽⁴⁾	Max	Unit
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INPUT LED

Forward Voltage ($I_F = 10\text{ mA}$)	V_F	—	1.15	1.5	V
Reverse Leakage Current ($V_R = 6.0\text{ V}$)	I_R	—	0.1	100	μA
Capacitance	C	—	18	—	pF

OUTPUT TRANSISTOR

Collector–Emitter Dark Current ($V_{CE} = 10\text{ V}$, $T_A = 25^\circ\text{C}$) ($V_{CE} = 10\text{ V}$, $T_A = 100^\circ\text{C}$)	I_{CEO1}	—	1.0	50	nA
	I_{CEO2}	—	1.0	—	μA
Collector–Emitter Breakdown Voltage ($I_C = 100\ \mu\text{A}$)	$V_{(BR)CEO}$	70	120	—	V
Emitter–Collector Breakdown Voltage ($I_E = 100\ \mu\text{A}$)	$V_{(BR)ECO}$	7.0	7.8	—	V
Collector–Emitter Capacitance ($f = 1.0\text{ MHz}$, $V_{CE} = 0$)	C_{CE}	—	7.0	—	pF

COUPLED

Output Collector Current ($I_F = 10\text{ mA}$, $V_{CE} = 10\text{ V}$)	MOC205 MOC206 MOC207 MOC208	I_C (CTR) ⁽⁵⁾	4.0 (40) 6.3 (63) 10 (100) 4.0 (40)	6.0 (60) 9.4 (94) 15 (150) 8.0 (80)	8.0 (80) 12.5 (125) 20 (200) 12.5 (125)	mA (%)
Collector–Emitter Saturation Voltage ($I_C = 2.0\text{ mA}$, $I_F = 10\text{ mA}$)		$V_{CE(sat)}$	—	0.15	0.4	V
Turn–On Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_{on}	—	3.0	—	μs
Turn–Off Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_{off}	—	2.8	—	μs
Rise Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_r	—	1.6	—	μs
Fall Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_f	—	2.2	—	μs
Input–Output Isolation Voltage ($f = 60\text{ Hz}$, $t = 1.0\text{ sec.}$) ^(1,2)		V_{ISO}	3000	—	—	Vac(rms)
Isolation Resistance ($V_{I-O} = 500\text{ V}$) ⁽²⁾		R_{ISO}	10^{11}	—	—	Ω
Isolation Capacitance ($V_{I-O} = 0$, $f = 1.0\text{ MHz}$) ⁽²⁾		C_{ISO}	—	0.2	—	pF

1. Input–Output Isolation Voltage, V_{ISO} , is an internal device dielectric breakdown rating.
2. For this test, pins 1 and 2 are common, and pins 5, 6 and 7 are common.
3. Refer to Quality and Reliability Section in Opto Data Book for information on test conditions.
4. Always design to the specified minimum/maximum electrical limits (where applicable).
5. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.

TYPICAL CHARACTERISTICS

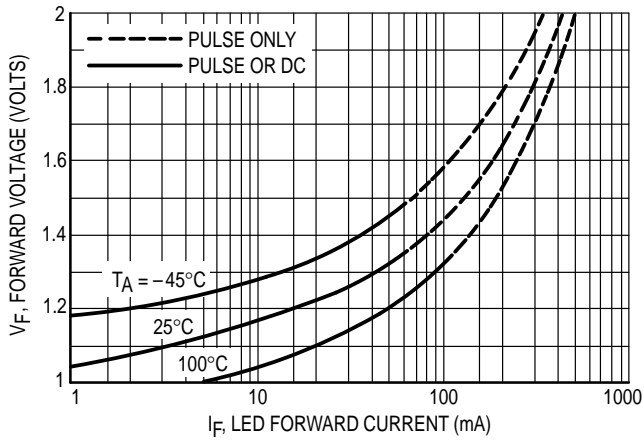


Figure 1. LED Forward Voltage versus Forward Current

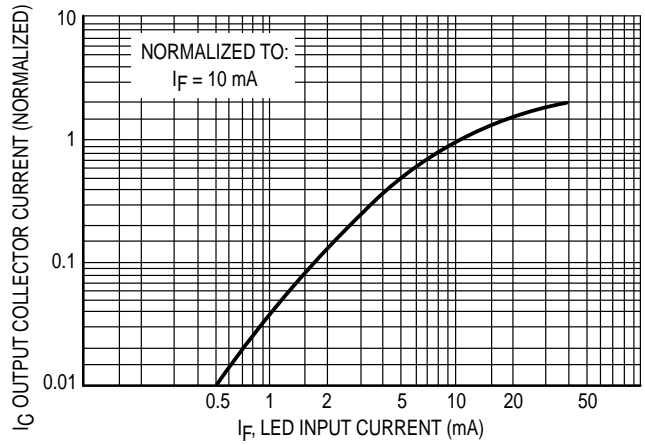


Figure 2. Output Current versus Input Current

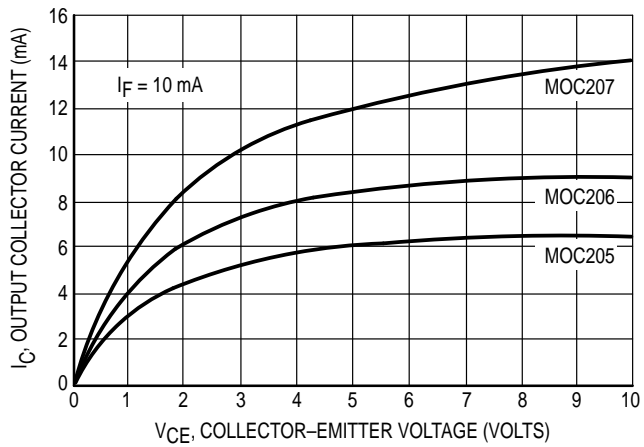


Figure 3. Output Current versus Collector-Emitter Voltage

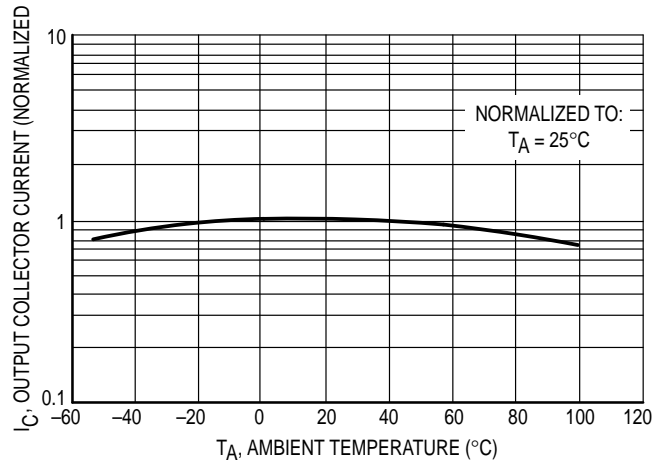


Figure 4. Output Current versus Ambient Temperature

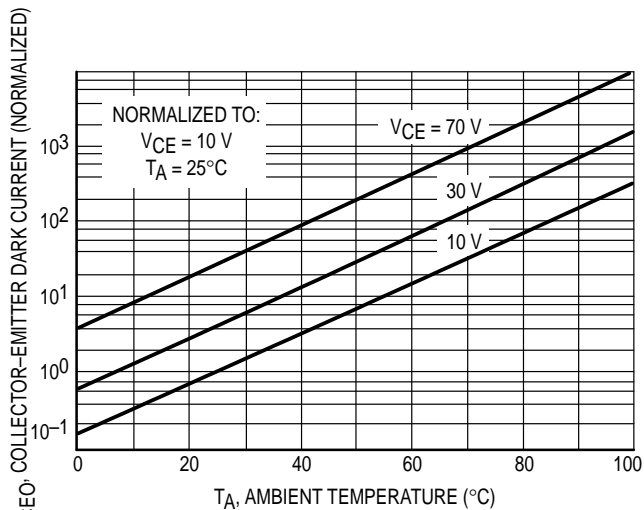


Figure 5. Dark Current versus Ambient Temperature

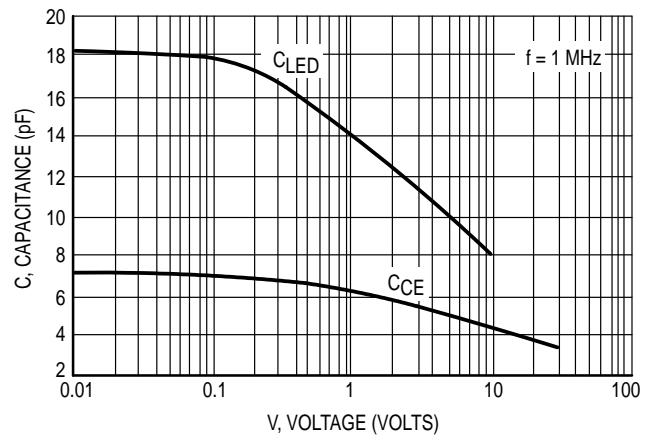
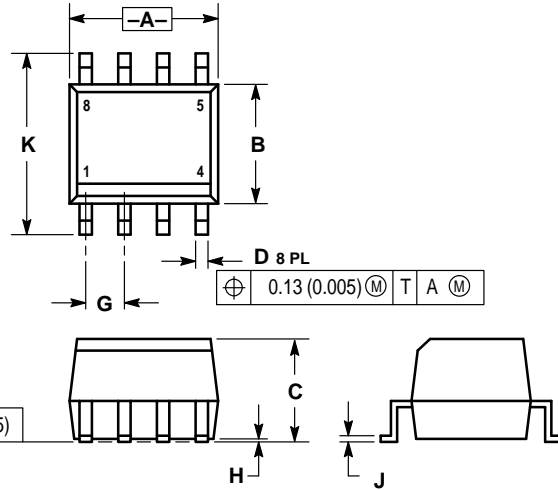


Figure 6. Capacitance versus Voltage



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.182	0.202	4.63	5.13
B	0.144	0.164	3.66	4.16
C	0.123	0.143	3.13	3.63
D	0.011	0.021	0.28	0.53
G	0.050 BSC		1.27 BSC	
H	0.003	0.008	0.08	0.20
J	0.006	0.010	0.16	0.25
K	0.224	0.244	5.69	6.19

- STYLE 1:
PIN 1. ANODE
2. CATHODE
3. NC
4. NC
5. EMITTER
6. COLLECTOR
7. BASE
8. NC

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